

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J.-S. Mok et al. Attorney Docket No.: LEPA121687
Application No.: 10/677,182 Art Unit: 1792 / Confirmation No: 8329
Filed: October 2, 2003 Examiner: S. Ahmed
Title: METHOD OF FORMING SOLDER RESIST PATTERN

AMENDMENT AFTER NON-FINAL REJECTION

Seattle, Washington 98101

February 15, 2008

TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

Please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of the claims, which begins on page 2 of this paper.

Remarks/Arguments begin on page 9 of this paper.

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